## **Application Data Sheet**

Middle Name::

| Application Information          |                                 |
|----------------------------------|---------------------------------|
| Application Type::               | Regular                         |
| Subject Matter::                 | Utility                         |
| Suggested Classification::       |                                 |
| Suggested Group Art Unit::       |                                 |
| CD-ROM or CD-R?::                | None                            |
| Number of CD Disks::             |                                 |
| Number of Copies of CDs::        |                                 |
| Sequence Submission?::           |                                 |
| Computer Readable Form (CRF)?::  |                                 |
| Number of copies of CRF::        |                                 |
| Title::                          | DIE FOR MOLDING DISC SUBSTRATES |
| Attorney Docket Number::         | EBINA4                          |
| Request for Early Publication?:: | No                              |
| Request for Non-Publication?::   | No                              |
| Suggested Drawing Figure::       |                                 |
| Total Drawing Sheets::           | 3                               |
| Small Entity?::                  | Yes                             |
| Latin Name::                     |                                 |
| Variety Denomination Name::      |                                 |
| Petition Included::              | No                              |
| Petition Type::                  |                                 |
| Licensed US Govt. Agency::       |                                 |
| Contract or Grant Numbers::      |                                 |
| Secrecy Order in Parent Appl.?:: | No                              |
| Applicant Information            |                                 |
| Applicant Authority Type::       | Inventor                        |
| Primary Citizenship Country::    | Japan                           |
| Status::                         | Full Capacity                   |
| Given Name::                     | Toshiyuki                       |

Family Name:: EBINA

Name Suffix::

City of Residence:: Aichi-ken

State or Province of Residence::

Country of Residence:: Japan

Street of Mailing Address:: Meiki Seisakusho Nai, 2, Ohne, Kitasaki-

cho, Ohbu-shi

City of Mailing Address:: Aichi-ken

State or Province of Mailing Address::

Country of Mailing Address:: Japan

Postal or Zip Code of Mailing Address:: 474

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Kazuki

Middle Name::

Family Name:: NISHI

Name Suffix::

City of Residence:: Aichi-ken

State or Province of Residence::

Country of Residence:: Japan

Street of Mailing Address:: Meiki Seisakusho Nai,2, Ohne, Kitasaki-

cho, Ohbu-shi

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Postal or Zip Code of Mailing Address:: 474

**Correspondence Information** 

Correspondence Customer Number:: 001444

**Representative Information** 

Representative Customer Number:: 001444

**Domestic Priority Information** 

Application:: Continuity Type:: Parent Parent Filing

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Application::

Date::

**Foreign Priority Information** 

Country::

Application Number::

Filing Date::

Priority Claimed::

Japan

2003-135230

05/14/03

Yes

**Assignment Information** 

Assignee Name::

Kabushiki Kaisha Meiki Seisakusho

Street of Mailing Address::

2, Ohne, Kitasaki-cho, Ohbu-shi

City of Mailing Address::

State or Province of Mailing Address::

Aichi-ken

Country of Mailing Address::

Japan

Postal or Zip Code of Mailing Address::

474